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January 2008

74LVTH125 Low Voltage Quad Buffer with 3-STATE Outputs

Features

- Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink –32mA/+64mA
- Functionally compatible with the 74 series 125
- Latch-up performance exceeds 500mA
- ESD performance:
 - Human-body model > 2000V
 - Machine model > 200V
 - Charged-device model > 1000V

General Description

The LVTH125 contains four independent non-inverting buffers with 3-STATE outputs.

These buffers are designed for the volume $(3.3V) V_{CC}$ applications, but with the sapable v to ovide a TTL interface to a 5V environment. The Uniterface to a 5V environment The Uniterface to a for the volume of the Uniterface to a for the Uniterface to a for the volume of the Uniterface to a for the Uniterface to

Ordering	Informat:
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Pi kage Order Numh Nu ber	Package Description
Order Numh . Nu. her	Package Description
74LVTH1 5M 114A	14-Lead Small Culline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74 ¹ , 12: 1/14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
1LVTH 5M MTG14	1 - Pad Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devic Liso available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per IEDEC: J-STD-020B standard.

74LVTH125 — Low Voltage Quad Buffer with 3-STATE Outputs **Connection Diagram** Logic Symbol IEEE/IEC Ā ∕cc B₀ ▶ 1 13 B₀ A₂ ∇ 00 Ā₀ ΕN 12 B₂ 00 B₁ 11 0, A ∇ 01 Ā 10 Āz B₁ B₂ 9 01 В3 ∇ 02 \overline{A}_2 8 GND 03 B₃ 03 Ā3 **Pin Description Truth Table** Pin Names Description In outs Output \overline{A}_n , B_n Inputs Ú., On **3-STATE Outputs** Ā В Н Х H. H = HIGH Voltage Level A = immaterial x = immaterial z = HICH In.pac FECONIVE FOR FOR FECONIVE FECONIVE FOR FECONIVE FOR FECONIVE FECONIVE FECONIVE FECONIVE FOR FECONI = LCW Voitage Level = HICH Impedance

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +4.6V
VI	DC Input Voltage	-0.5V to +7.0V
Vo	DC Output Voltage	
	Output in 3-STATE	-0.5V to +7.0V
	Output in HIGH or LOW State ⁽¹⁾	-0.5V to +7.0V
I _{IK}	DC Input Diode Current, V _I < GND	_50mA
I _{ок}	DC Output Diode Current, V _O < GND	-50mA
Ι _Ο	DC Output Current, V _O > V _{CC}	
	Output at HIGH State	64mA
	Output at LOW State	128mA
I _{CC}	DC Supply Current per Supply Pin	±64mA
I _{GND}	DC Ground Current per Ground Pin	±128mA
T _{STG}	Storage Temperature	−65° C tc → 150°C
Note:		13 11

Note:

Recommended Operation Cor itions

The Recommended Operating Columb Colu

Symb '	Pararieter	Min	Мах	Units
	Stonk oltage	2.7	3.6	V
V _I	nput Voltage	0	5.5	V
Іон	HIGH-Level Output Carrent		-32	mA
JL	LOW-Leve! Output Current		64	mA
TA	Free-Air Operating Temperature	-40	85	°C
Δ^{+}/Δ^{V}	Input Edge Rate, $V_{IN} = 0.8V - 2.0V$, $V_{CC} = 3.0V$	0	10	ns/V

^{1.} I_O Absolute Maximum Rating must be o' ved.

				T _A = -40°C to +85°C			
				Min.	Typ. ⁽²⁾	Max.	1
Symbol	Parameter	V _{CC} (V)	Conditions			-	Units
V _{IK}	Input Clamp Diode Voltage	2.7	$I_I = -18 \text{mA}$			-1.2	V
V _{IH}	Input HIGH Voltage	2.7–3.6	$V_0 \le 0.1V$ or	2.0			V
V _{IL}	Input LOW Voltage	2.7–3.6	$V_{O} \ge V_{CC} - 0.1V$			0.8	V
V _{OH}	Output HIGH Voltage	2.7–3.6	I _{OH} = -100μA	V _{CC} - 0.2			V
		2.7	I _{OH} =8mA	2.4			1
		3.0	I _{OH} = -32mA	2.0			1
V _{OL}	Output LOW Voltage	2.7	$I_{OL} = 100 \mu A$			0.2	V
			$I_{OL} = 24 \text{mA}$			0.5	C
		3.0	I _{OL} = 16mA			0.4	K
			$I_{OL} = 32 \text{mA}$			9.5	
			$I_{OL} = 64 \text{mA}$			0.55	1
I _{I(HOLD)}	Bushold Input Minimum Drive	3.0	$V_{\rm I} = 0.8^{\rm V}$	75	4		μA
			V _J - ¹ .0V	-15			
I _{I(OD)}	Bushold Input Over-Drive	3.0		500			μA
	Current to Change State		1)	-500			1
l _l	Input Current	C.	V, 5.5V	0	10	10	μA
	Control Pins		$V_{I} = 0V$ or V_{CC}	- 0	14.	±1	1
	Datr ins	3.6	VI-CV	20		-5	1
			V = V _{CC}	21		1	1
I _{OFF}	Power Off Le lage Curre.	0	$0V \le V_1 \text{ or } V_0 \le 5.5$			±100	μA
I _{PU/PD}	Power 'dov 3-STA	0-1.5	$V_{i,j} = 0.5V$ to 3.0 /,			±100	μA
	Ou ut Current	101	$V_I = GND$ or V_{CC}				
I _{OZL}	-SIGE Ou ut Leakage Current	3.6	Vo = 0.5V			-5	μA
JZh	3 TA. atput Leakage Current	3.6	$v_0 = 3.0V$			5	μA
יאבא+	3-S JE Output Leakage Current	36	$V_{CC} < V_O \le 5.5V$			10	μA
. н	Power Supply Current	3.6	Outputs HIGH			0.19	mA
ICCL	Pcwai Supply Ourreat	3.6	Outputs LOW			5	mA
Iccz	Power Supply Curren	3.6	Outputs Disabled			0.19	mA
I _{CC2} +	Power Supply Curiont	3.6	$V_{CC} \le V_O \le 5.5V$, Outputs Disabled			0.19	mA
ΔI_{CC}	Increase in Power Supply Current ⁽⁵⁾	3.6	One Input at $V_{CC} - 0.6V$, Other Inputs at V_{CC} or GND			0.2	mA

74LVTH125 — Low Voltage Quad Buffer with 3-STATE Outputs

Notes:

2. All typical values are at V_{CC} = 3.3V, T_A = 25 ^{\circ}C.

3. An external driver must source at least the specified current to switch from LOW-to-HIGH.

4. An external driver must sink at least the specified current to switch from HIGH-to-LOW.

5. This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics(6)

			Conditions	T _A = 25°C			
Symbol	Parameter	V _{CC} (V)	$C_L = 50 \text{ pF, } R_L = 500\Omega$	Min.	Тур.	Max.	Units
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3	(7)		0.8		V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3	(7)		-0.8		V

Notes:

6. Characterized in SOIC package. Guaranteed parameter, but not tested.

7. Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

AC Electrical Characteristics

		V _{cc}	$T_{A} = -4$ $C_{L} = 50$ $= 3 V 2$	0°`to 0pF, = 3V	C, IDC VCC	2.7V	OF
Symbol	Parameter		τ _{νp.} ')		tv]in.	Max.	Units
t _{PLH}	Propagation Delay, Data to Output	1.		35	1.0	4.5	ns
t _{PHL}		1.0		3.9	1.0	4.9	
t _{PZH}	Output Enable Time	0		4.0	1.0	5.5	ns
t _{PZL}		1.	<u>N</u>	4.0	1.	5.4	
t _{PHZ}	Output Disable Tir	1.5		4.5	1.5	5.7	ns
t _{PLZ}		1.3	নিচ	1.5	1.3	4.0	
t _{OSHL} , t _{OSLH}	Output cuput 'rew ⁽⁹⁾			1.0		1.0	ns

Notes:

8. All typical vr les are a. '---- J.3V, T_A - 25 C.

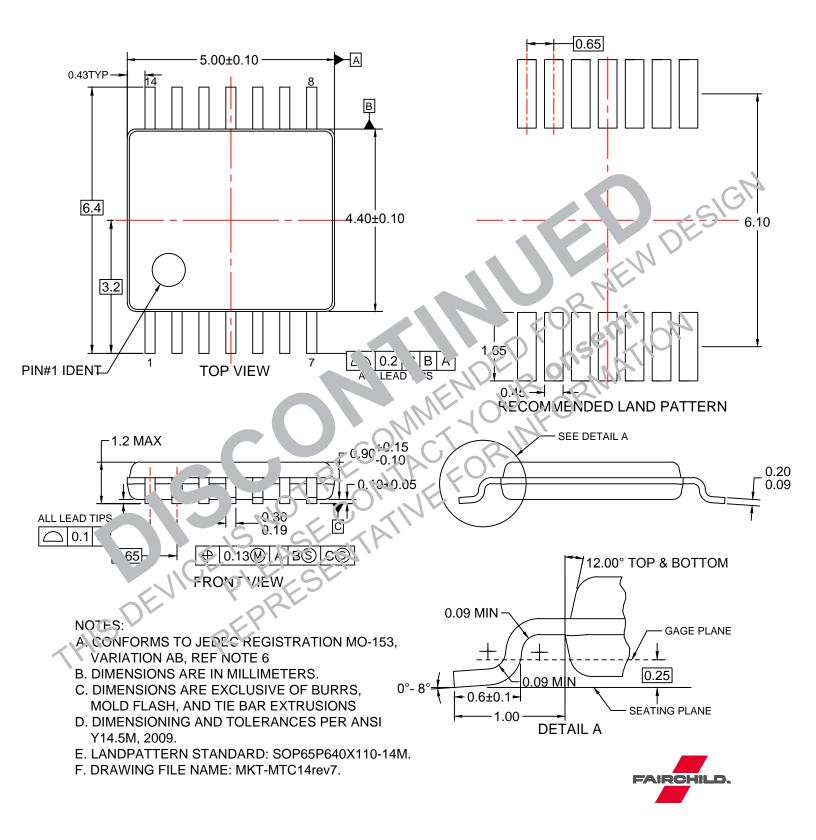
9. Skew i tefi. absolute value of the difference between the actual propagation delay for any two separate utputs of e same device. The specification applies to any outputs switching in the same direction, une. "IG. to-Lovv (t_{CSHL}) or LOW- or HIGH (t_{CSLH}).

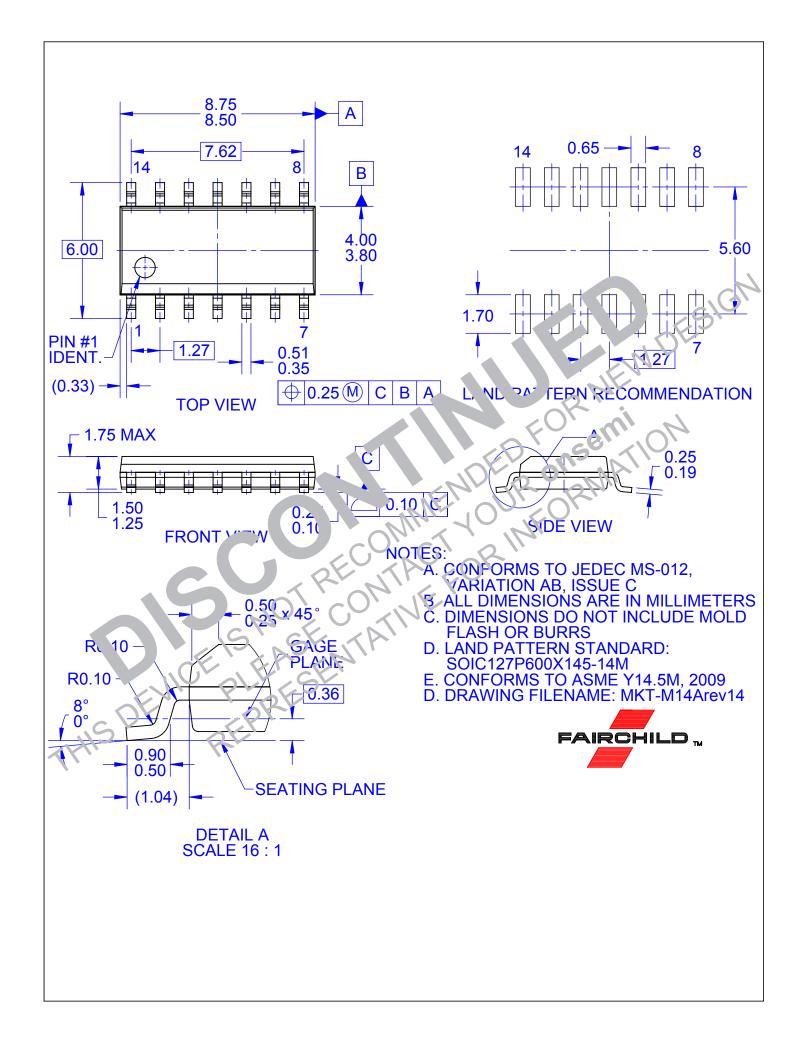
Cap Jitance⁽¹⁰⁾

	Symbol Parameter		Conditions	Typical	Units	
C	C _{IN}	Input Capacitance	$V_{CC} = 0V, V_I = 0V \text{ or } V_{CC}$	4	pF	
	C _{OUT}	Output Capacitance	V_{CC} = 3.0V, V_{O} = 0V or V_{CC}	8	pF	

Note:

10. Capacitance is measured at frequency f = 1MHz, per MIL-STD-883B, Method 3012.





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